SEP ELECTRONIC CORP.

DB301 thru DB310

SURFACE MOUNT GLASS PASSIVATED BRIDEG RECTIFIERS

REVERSE VOLTAGE - 50 to 1000 Volts FORWARD CURRENT - 3.0 Amperes

FEATURES

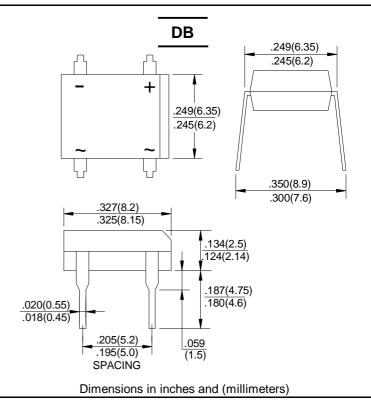
- ●Rating to 1000V PRV
- ●Ideal for printed circuit board
- Low forward voltage drop, high current capability
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- ●Lead tin Pb/Sn copper
- The plastic material has UL flammability classification 94V-0

MECHANICAL DATA

◆Polarit: As marked on Body

●Weight: 0.02 ounces,0.38 gras

Mounting position: Any



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave ,60Hz, resistive or inductive load.

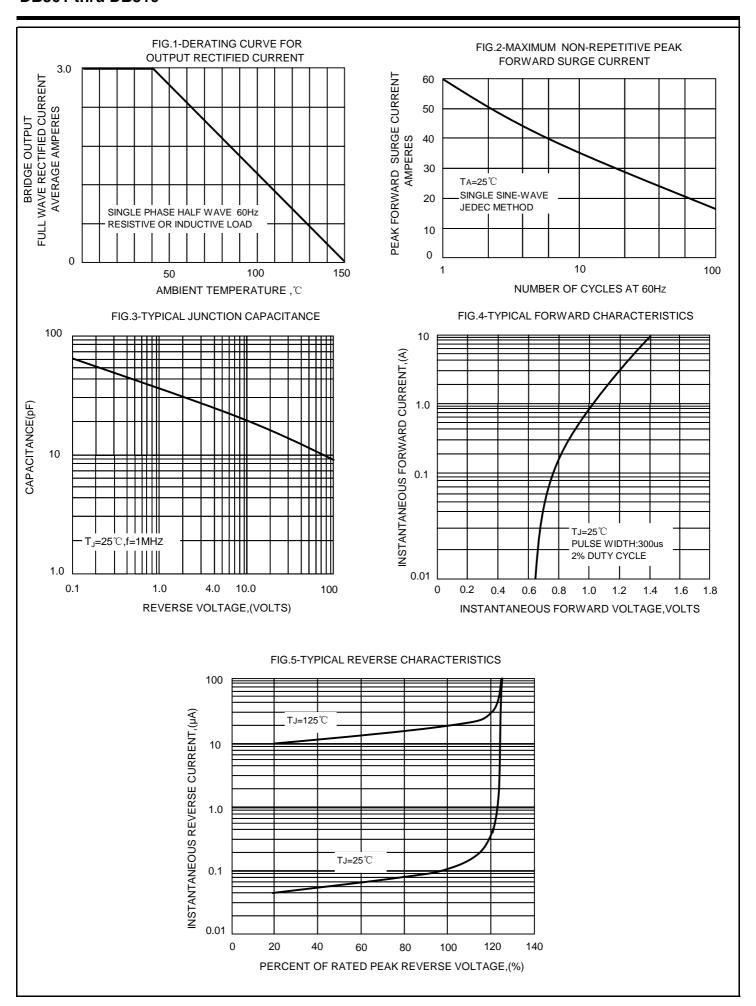
For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	DB301	DB302	DB303	DB304	DB305	DB306	DB310	UNIT
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @Ta=40℃	I(AV)	3.0							Α
Peak Forward Surage Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC .Method)	IFSM	90							Α
Maximum Forward Voltage at 2.0A DC	VF	1.1							V
Maximum DC Reverse Current @TJ=25℃ at Rated DC Blocking Voltage @TJ=125℃	lR	10 500							uA
I ² t Rating for Fusing (t<8.3ms)	l ² t	10.4							A ² s
Typical Junction capacitance Per Element(Note1)	C1	25							pF
Typical Thermal Resistance (Note2)	Rejc	40							°C/W
Operating Temperature Range	TJ	-55 to +150							$^{\circ}\!\mathbb{C}$
Storage Temperature Range	Тsтg	-55 to +150							$^{\circ}\!\mathbb{C}$

Note:1.Measured at 1.0MHz and applied reverse voltage of 4.0V DC

2.Thermal resistance from junction to ambient mounted on P.C.B with 0.5*0.5"(13*13mm) copper pads.

RATING AND CHARACTERISTIC CURVES DB301 thru DB310



单击下面可查看定价,库存,交付和生命周期等信息

>>SEP(威旺)